

CERTIFICATE OF INSPECTION & TEST

ORIGINAL



ST&H CORPORATION
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(EN 10204 3.1)

Certified to ISO9001:2008, ISO14001:2004, PED97/23/EC by LRQA

Certified API Spec Q1 and API Spec 6A (Licence No : 6A-1284)



Customer : PLESA ANAHUAC Y CIAS.,S.A DE C.V.				Contract No. : 15982				Report No : MSH8188				Date: SEP.09.2013			
Spec. For Material : ASTM/ASME A/SAI05N-11(NACE MR0175/ISO 15156-2009)												Heat Treatment			
Chemical Composition (%)		C	Si	Mn	P	S	Ni	Cr	Mo	Cu	V	910°C NORMALIZED & A C			
Heat No./Batch no.	MAX	0.350	0.350	1.050	0.035	0.040	0.400	0.300	0.120	0.400	0.080				
	MIN		0.100	0.600											
T1069J		0.203	0.252	0.930	0.020	0.008	0.025	0.071	0.002	0.025	0.002	Dimensional Inspection			
Tension Test						Charpy Impact Test (10x10 mm Specimen Size)						Hardness Test (HB)		Bending Test 90:120(180°)	
Size of Specimen(mm)		Yield Strength MPa	Tensile Strength MPa	Elongation %	Red of Area %	Individual min		Average min		Notch Type		Temp	GOOD		
Dia	Gage Length					Test Result									
12.5	50	MAX								187		ANSI B16.5 - 2009			
		MIN	250.000	485.000	22.000	30.000	①	②	③	Average					
12.5	50		329.000	519.000	37.000	64.000						158, 169		Ultrasonic Examination	
ITEM / SIZE			Q'TY	ITEM / SIZE			Q'TY	ITEM / SIZE			Q'TY	Ultrasonic Examination			
300LBS SORF 6"			41	BLANK				BLANK				N/A			
BLANK												Magnetic Particle Examination			
												N/A			
												Remarks :			
												**CE = 0.38 (LONG FORMULAR)			

NOTE :
 1MPa = 145.037 psi
 1MPa = 0.145037 ksi
 1psi = 0.006895 MPa
 1ksi = 6.89476 MPa

W.C:Water Cool O.C.Oil Cool
 A.C:Air Cool N.A:Non Action
 N:Normalized A:Annealed
 Q.T:Quenched and Tempered
 N.T:Normalized and Tempered

We hereby certify that the material herein has been made and tested in accordance with the above specification and also with the requirements called for by the above order.

[Signature]



Witnessed by / H. J. LEE Manager of Q.A Dept. / S. H. LEE